IPC ASSOCIATION CON	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		This docum level parts, t	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1					Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information			
upplier In	formation												
Company name*			Company unique ID			Unique ID Authority				Response Date*			
nsemi										2024-04-19			
Contact Name			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*		Title - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Re	equester Item Number	Mfr Item	Number	Mfr Item Name		Effective D	ate Ver	rsion	Manufacturing Site	We	ight*	UOM	Unit Type
		0W635-006-XTP EZAIRO 5920 Remodule			IS COMPLIA - Laminate	2024-04-19	19 CA1		60.	2	mg	Each	
	ring Proccess Informa												
Terminal Plating / Grid Array Material Terminal Base Alloy J			Alloy J-S	STD-020 MSL Rating	<del>-                                     </del>				Temperature	Number	r of Reflow Cyc	eles	
SnAgCu		CU Alloy 3			260		C	30	seconds	3			
omments													
<u> TENTION</u>	: MSL 3 Rated item requir	es Bake and D	ry Pack (after	r electrical test)									
or more info	rmation regarding materia	l composition <b>j</b>	please refer to	page 3									

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itaalian agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Condition										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Capacitor	7.6	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		1.5183	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		0.0231	mg
			Supplier	Tin (Sn)	7440-31-5		0.3102	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0923	mg
			Supplier	Misc.	Proprietary Data		0.5061	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		3.0366	mg
			В	Nickel (Ni)	7440-02-0		2.1134	mg
			Supplier	Barium Titanate (BaO3Ti)	12047-27-7		-0.5014	mg
			Supplier	Copper (Cu)	7440-50-8		-6.4352	mg
Die	10.68837	mg	Supplier	Silicon (Si)	7440-21-3		10.6884	mg
Laminate Board	19.3891	mg		Other Epoxy resins	proprietary data		5.912	mg
			Supplier	Inorganic filler	13776-74-4, 7631- 86-9, 21645-51-2		0.4598	mg
			Supplier	Fiber Glass (SiO2)	65997-17-3		4.214	mg
			Supplier	Palladium (Pd)	7440-05-3		0.007	mg
			В	Nickel (Ni)	7440-02-0		0.2585	mg
			Supplier	Gold (Au)	7440-57-5		0.0094	mg
			Supplier	Copper (Cu)	7440-50-8		8.5258	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7		0.0026	mg
Mold Compound-Black	18.56393	mg		Epoxy resin	proprietary data		1.4851	mg
			Supplier	Phenol Resin	Proprietary Data		0.9282	mg
			Supplier	Metal Hydroxide	Proprietary Data		0.1856	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		4.641	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1856	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.1384	mg
Solder Paste	3.27	mg	Supplier	2-(2-Hexyloxyethoxy) ethanol	112-59-4		0.1308	mg
			Supplier	Denatured Acid Hydrogenation Rosin	Proprietary		0.1308	mg
			Supplier	Dimer Acid	Proprietary		0.0654	mg
			Supplier	Silver (Ag)	7440-22-4		0.0981	mg
			Supplier	Tin (Sn)	7440-31-5		2.8122	mg
			Supplier	Copper (Cu)	7440-50-8		0.0327	mg
Wire Bond - Au	0.6886	mg	Supplier	Gold (Au)	7440-57-5		0.6886	mg